

Mechanical Polishing of 1.3 GHz Niobium Cavities

TESLA Technology Collaboration
Meeting

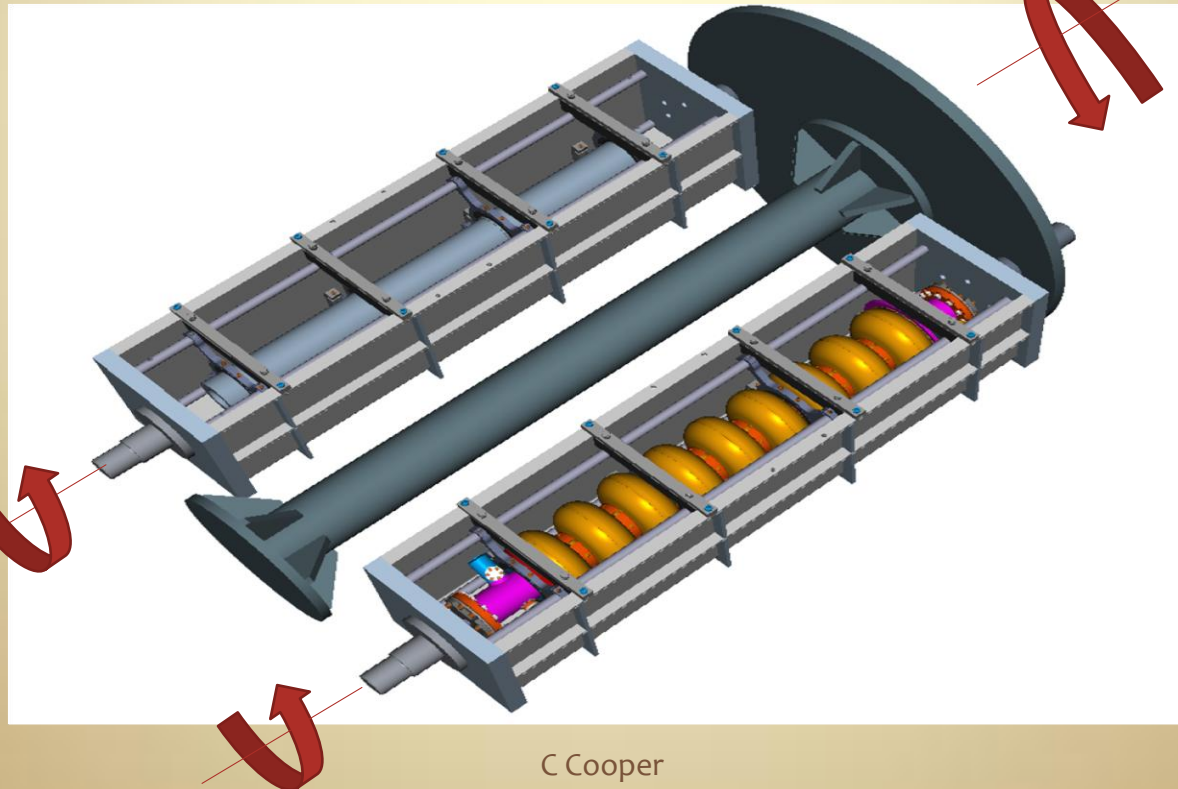
February 28 – March 3, 2011

Milano, Italy

Centrifugal Barrel Polishing (CBP)

CBP is a mechanical polishing process in which the inside of the cavity is filled with abrasive material and then rotated at high speeds.

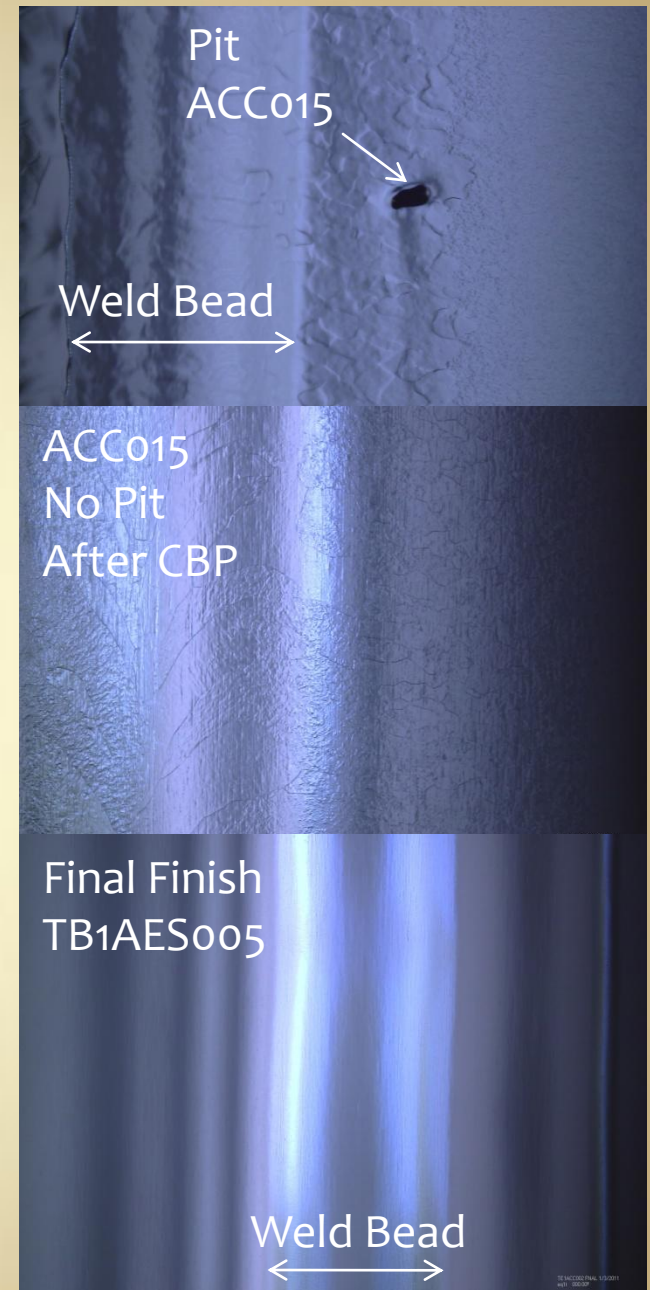
Individual
Barrels 115 RPM
in opposite
direction to
main shaft



Main Shaft
up to 115 RPM

Why do CBP?

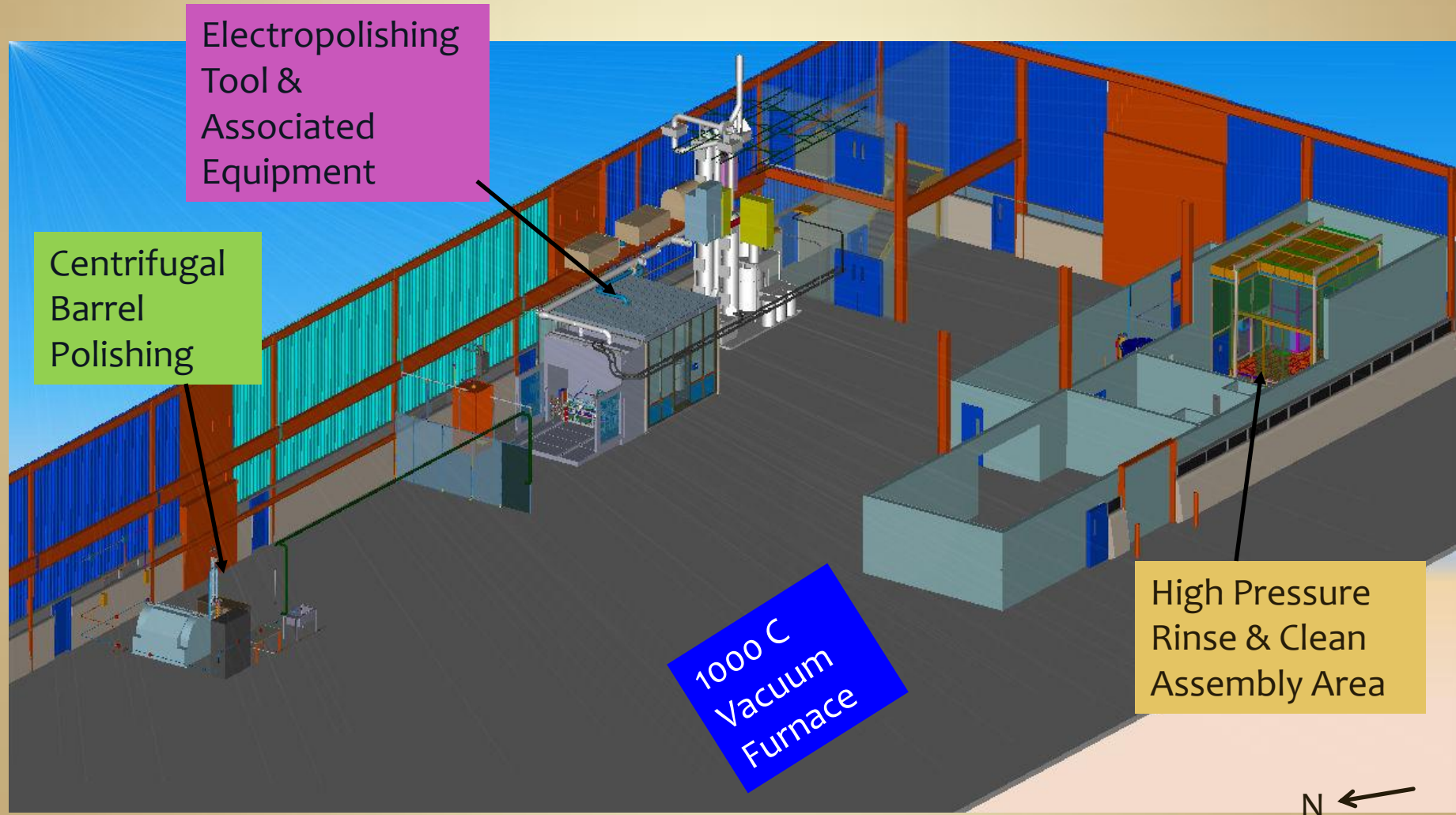
- **Uniform Surface Finish**
 - Remove weld beads and associated defects created from E-beam welding.
- **Smooth Surface Finish**
 - (Ra) on the order of 10s of nanometers. Best by EP alone is around 100 nanometers.
- **Environmentally Friendly.**
 - Most likely will still require a small amount of chemistry (on the order of 5-10 microns compared to 120 microns for EP)
- **Potential for cheaper installed & operating cost**
- **Repair of pit defects that chemistry can't remove**
- **Simple Technology**
 - Should prove to be a very repeatable process
 - Easy transfer to industry



Location of Centrifugal Barrel Polisher – IB4



General Layout of Integrated Cavity Processing Apparatus & CBP



Centrifugal Barrel Polisher & Rinse Station



Processed so far:

Two 9- Cell Tesla Type Cavities
Eight 1-Cell Tesla Type Cavities
Two 1-Cell 3.9 GHz Cavities

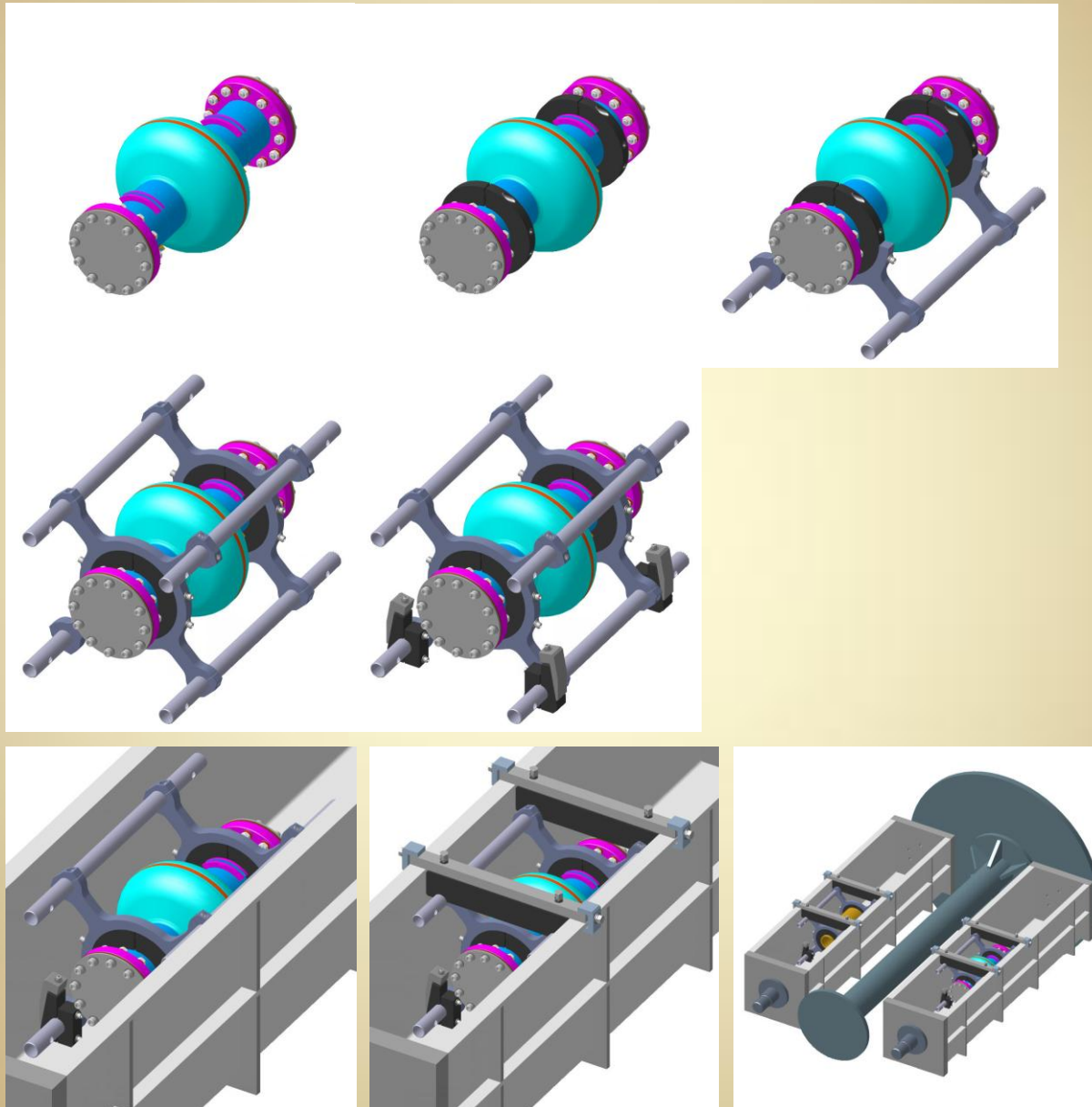
Currently Processing:

2 9-Cell Tesla Type Cavities
Concurrently

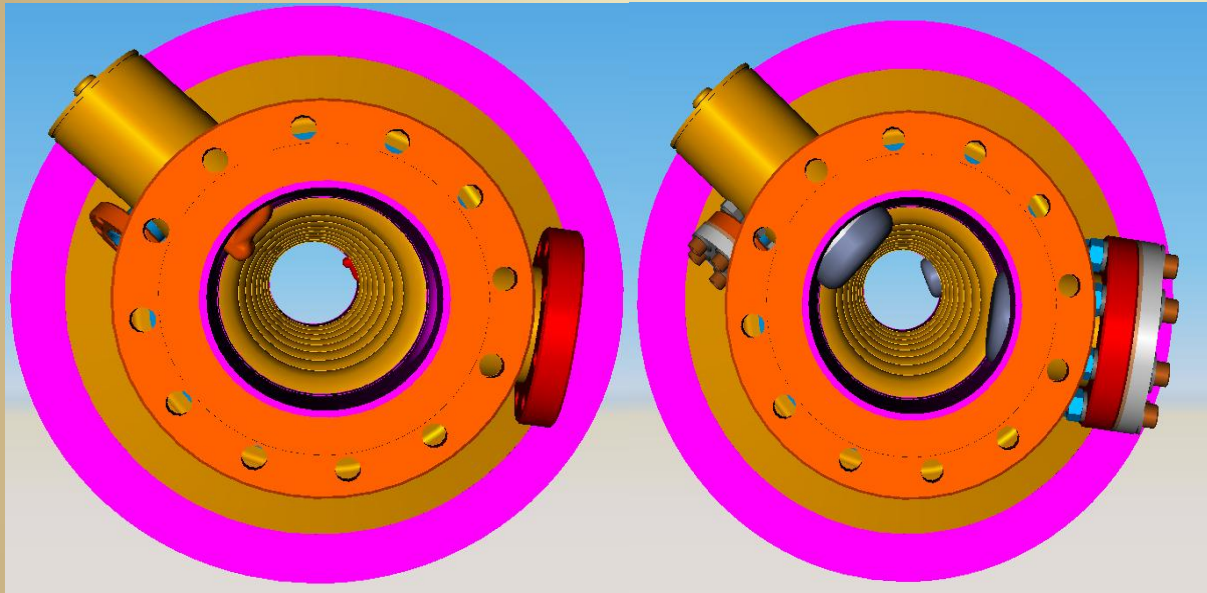
Probably Next for Processing:

4 9-Cell Tesla Type Cavities with
Pits
1 Single-Cell Tesla Type Cavity
2 Coupon Cavities
& hopefully 1 re-entrant cavity

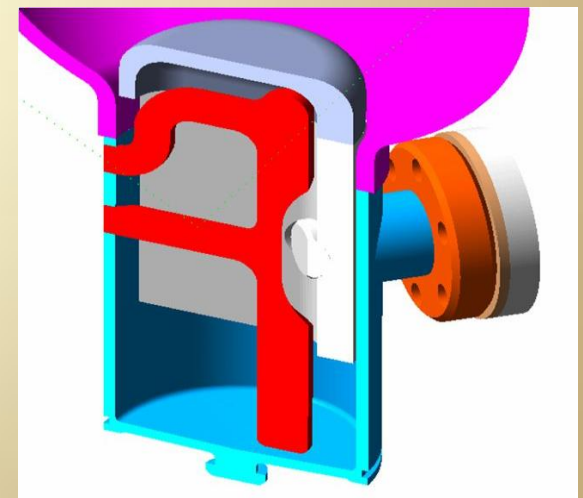
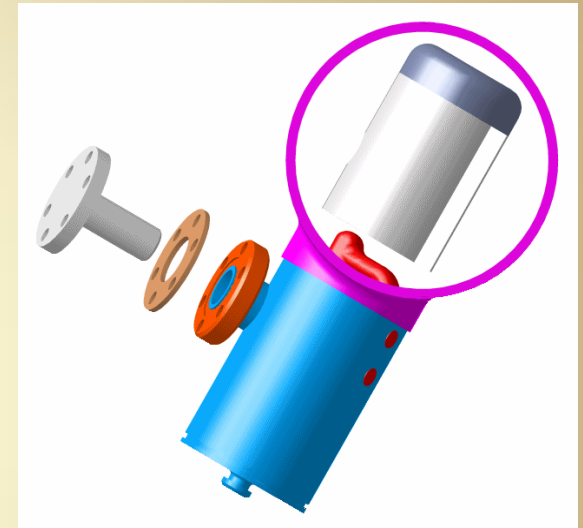
Cavity Preparation



9 Cell Cavity Tumbling



- HOM Can Must Be Protected or the Antenna Would be Destroyed.
- Caps are Made From Niobium to Avoid Contamination.



Current Media

Step 1

Cutting, Time
as needed



+ Soap &
Ultrapure
Water

Removal
Rate –
11 μm / hr

Step 2

Intermediate
Polishing, 12 hours



+ Soap &
Ultrapure
Water

Removal
Rate –
3 μm / hr

Step 3

Intermediate
Polishing, 15 hours



Water +
400
Mesh
Alumina



Step 4

Intermediate
Polishing, 20 hours



Water +
800
Mesh
Alumina



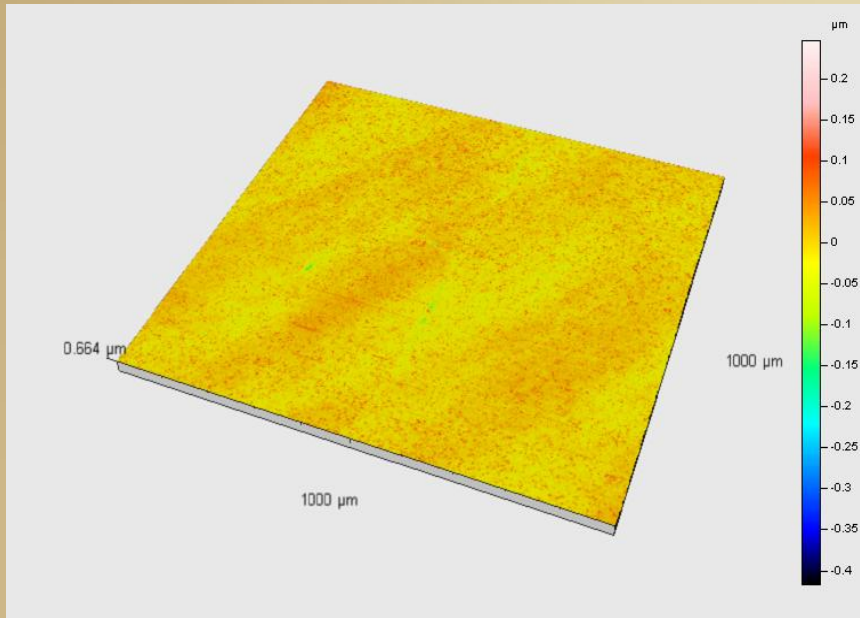
Step 5

Final
Polishing, 40 hours



Removal rate of final 3 steps is hard to
measure, but not nearly as much as 1st 2 steps

Results- Mirror Like Surface



Single Cell Polished to Mirror Finish

$R_a = 0.0139 \mu\text{m} \pm 0.00216 \mu\text{m}$

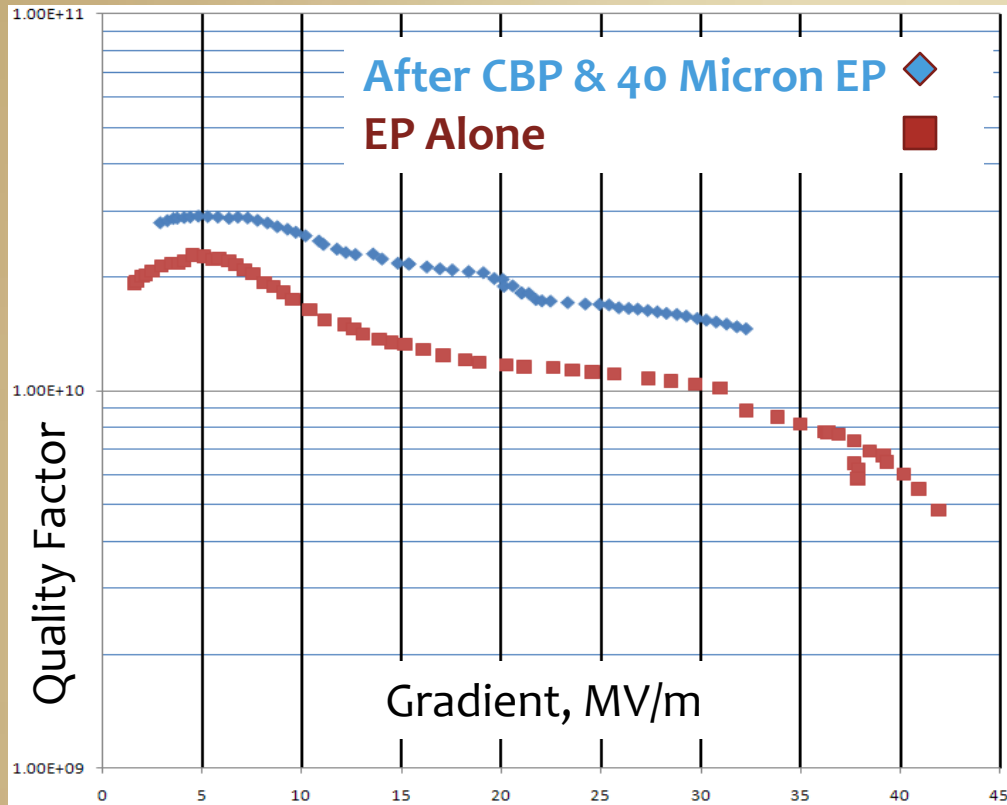
$R_z = 0.139 \mu\text{m} \pm 0.0242 \mu\text{m}$

Typical finish
achieved by fine
polishing.

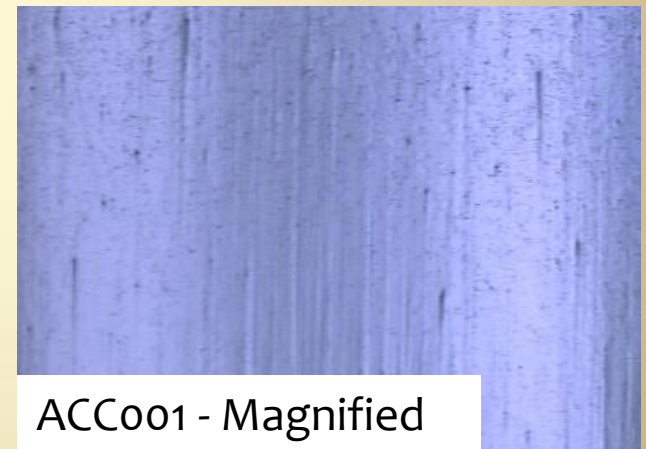
Notice reflection of
graph paper and
writing



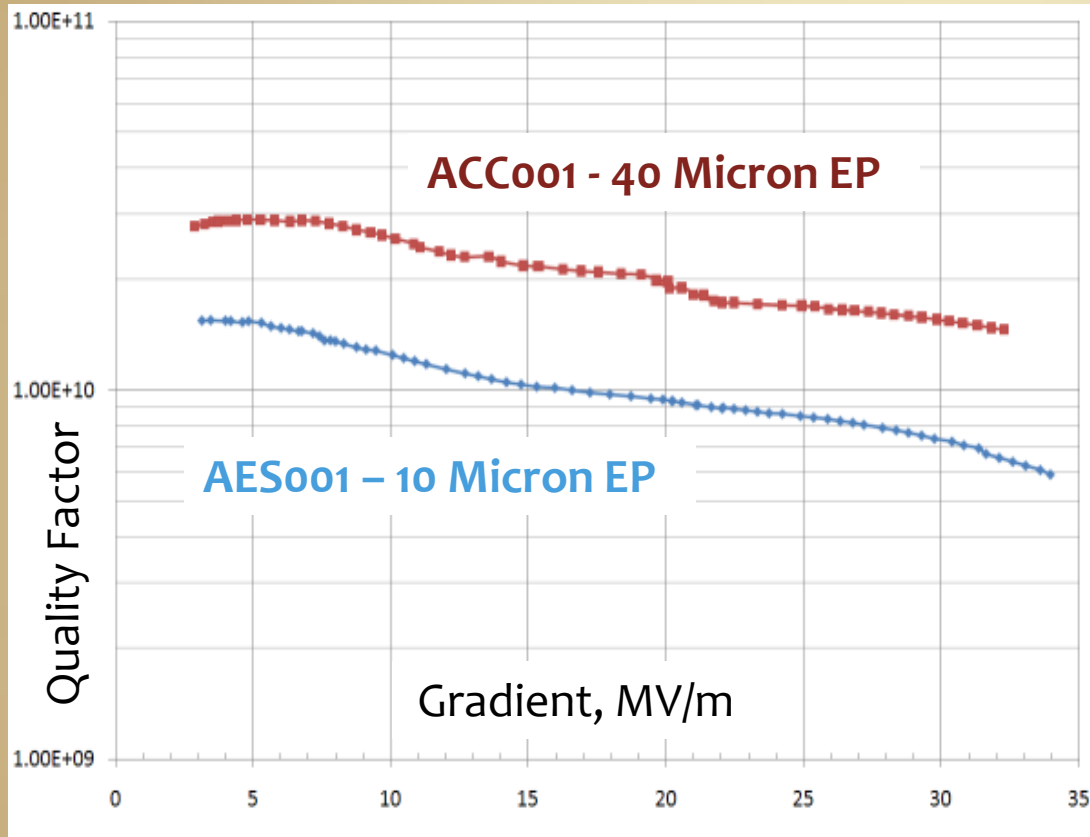
Results – ACC001



First cavity processed with colloidal silica tested worse than processing by EP because the first polishing step was 5 hours instead of 12, leaving **imbedded media** in the cavity



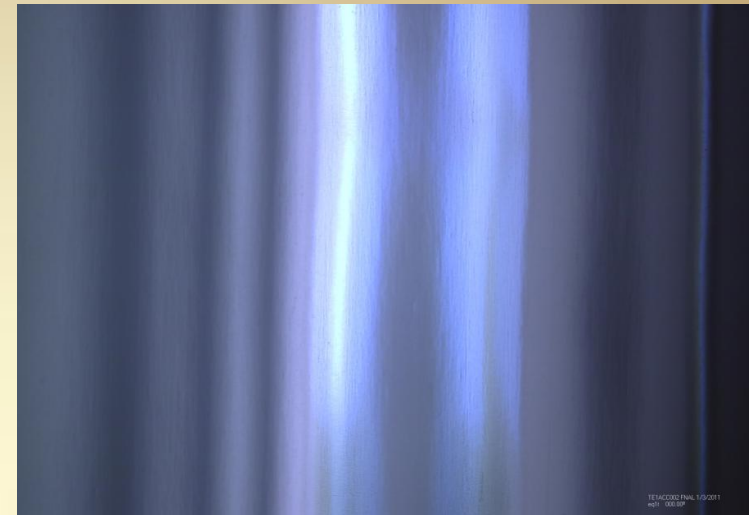
Results AES005



It is probable that the contamination layer is more than 10 microns deep and more EP is needed for AES005.

TTC Milano, 2011
02/03/2011

C Cooper

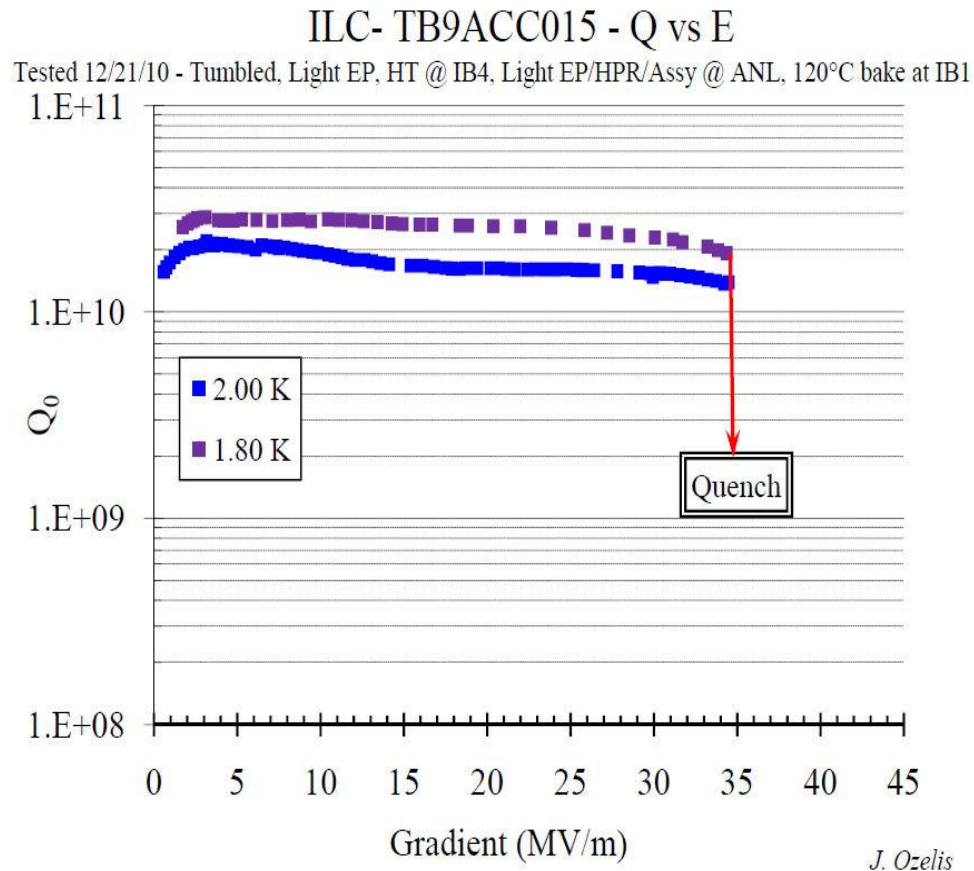


AES005 After CBP

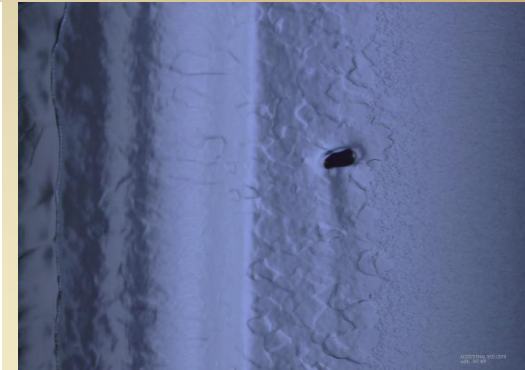


AES005 After 10 Microns EP

Results – Pit Repair



Had a large (~200micron) pit in cell 3 – previously processed and tested at JLab to 19 MV/m



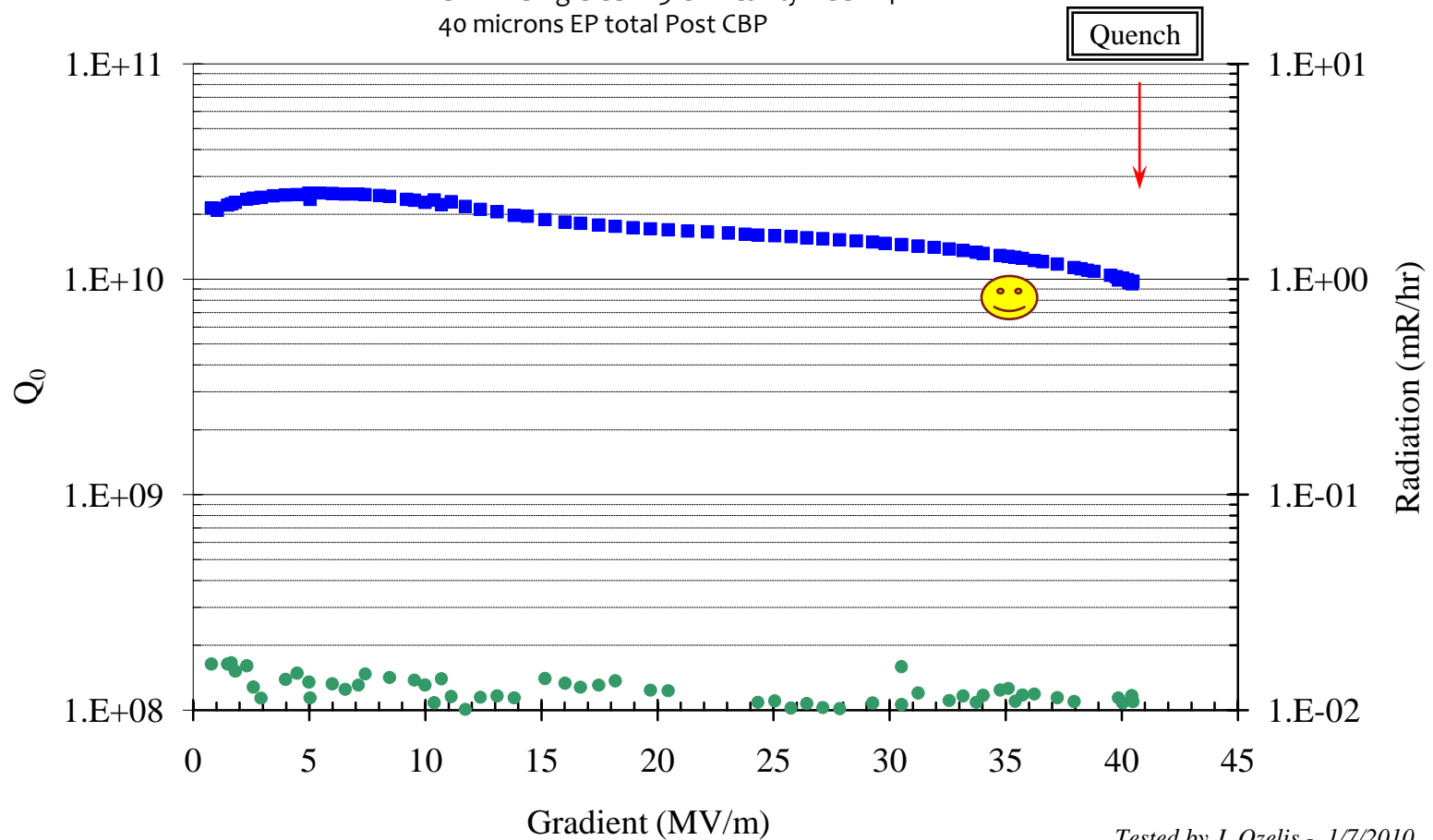
Before CBP



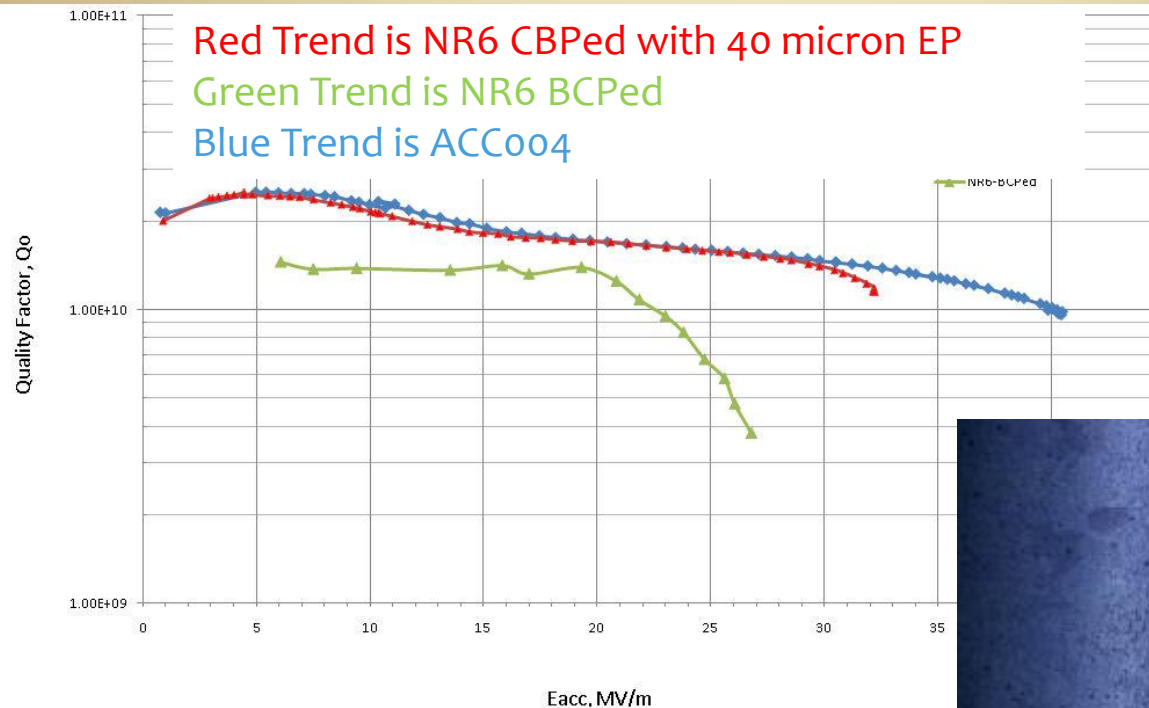
After CBP
and 40
microns Ep

Results - Single Cell Cavity ACC004

CBPED Single Cell 1.3 GHz Cavity ACC004
40 microns EP total Post CBP



Results - Single Cell Cavity NR6



NR6 and ACCoo4 have similar Q vs. E trends until 30 MV/m and were processed with completely different medias.

NR6 was tested after tumbling and reached as high as any of the other 6 single cell cavities from Niowave/Roark from that lot. Weld bead was successfully removed but surface shows general pitting after processing.



Results RRCAT2 Single Cell Performance

Tested 12/17/10 : Tumbling, HT, Light EP, HPR/Assy, then 120°C Bake @ IB1

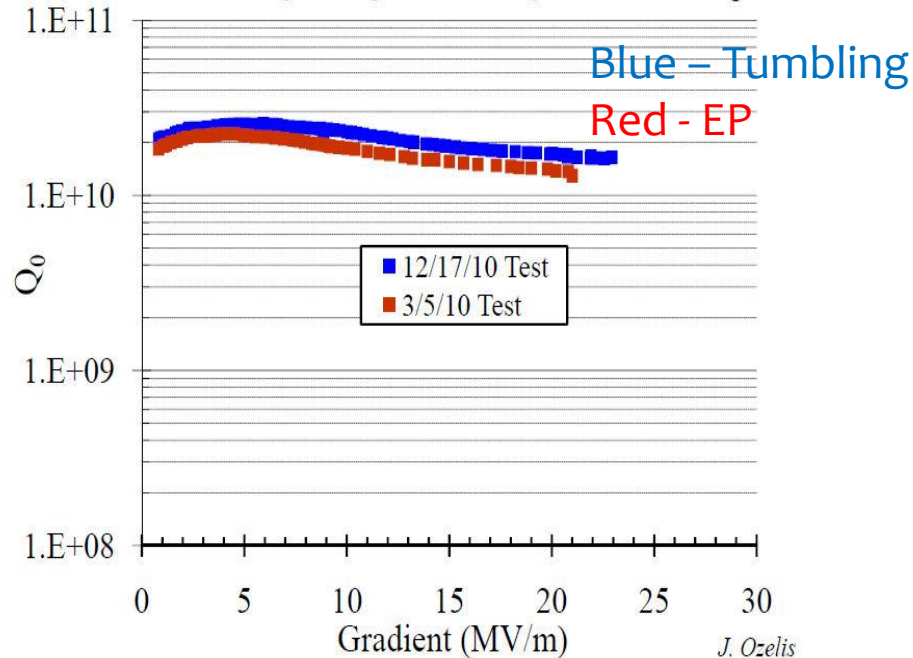
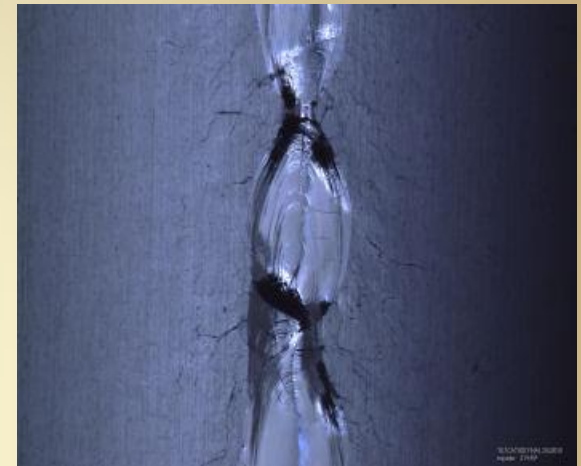
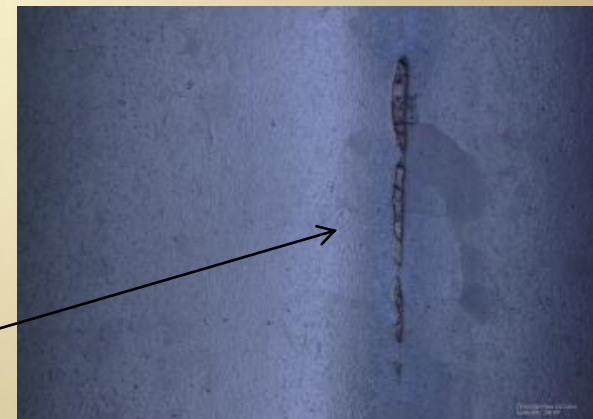


Figure 2. Comparison of Q_0 vs E @ 2K with previous result.



Irregular weld
Voids in weld by x-ray



After Processing Still Large Areas of
Weld Bead Not Removed

Conclusions & Future Plans

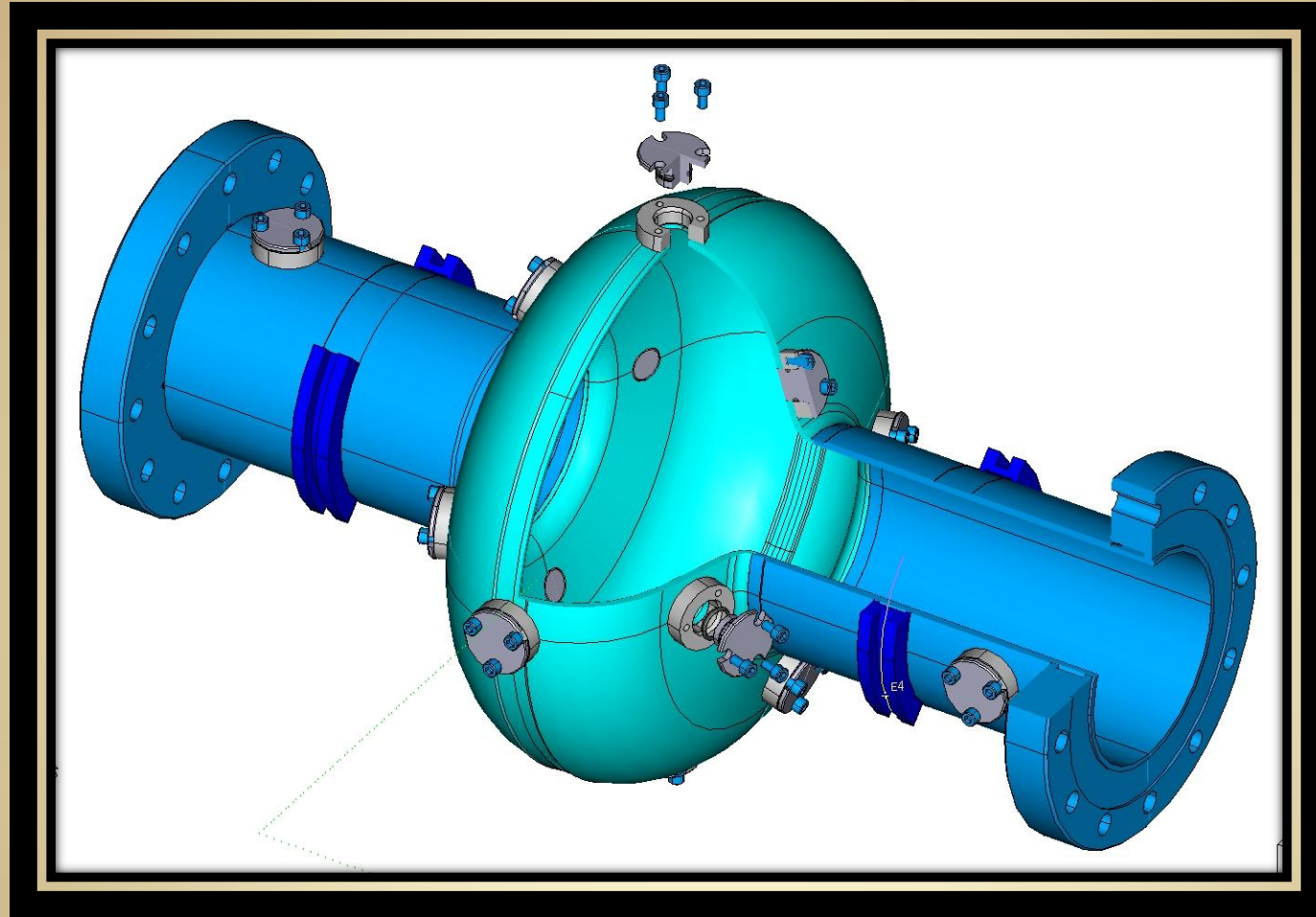
- **Conclusions**

- Preliminary R&D on CBP has identified a process that can yield mirror like finishes
- Between 40 and 20 microns of material still need to be removed by chemistry.
- Further work need to be done to perfect the CBP procedure.

- **Future Plans**

- Use coupon cavity to fine tune CBP process.
- Hopefully process re-entrant cavity to mirror finish in collaboration with Cornell.
- Correlate Ra to cavity performance.
- Evaluate amount of chemistry needed after CBP.
- Prepare single cell cavities for thin film studies.
- Examine processing 650MHz cavities

Future Plans - Coupon Cavity



- With the use of coupon cavities perfect process.
 - Use Surface Profilometry and SEM/EDS to determine the average surface roughness and chemical contamination present after each step.

Acknowledgements

- Cavity Testing
 - Joe Ozelis
- Centrifugal Barrel Polishing Operation
 - Dave Burk
 - George Steuer
- Baseline Cavity Processing
 - Brent Stone
 - Jim Folkie
 - Damon Bice
- Optical Inspection
 - Evgeny Toropov
 - Dmitri Sergatskov
- Kenji Saito for communications and information about the CBP process.
- Camille Ginsburg for help in general.